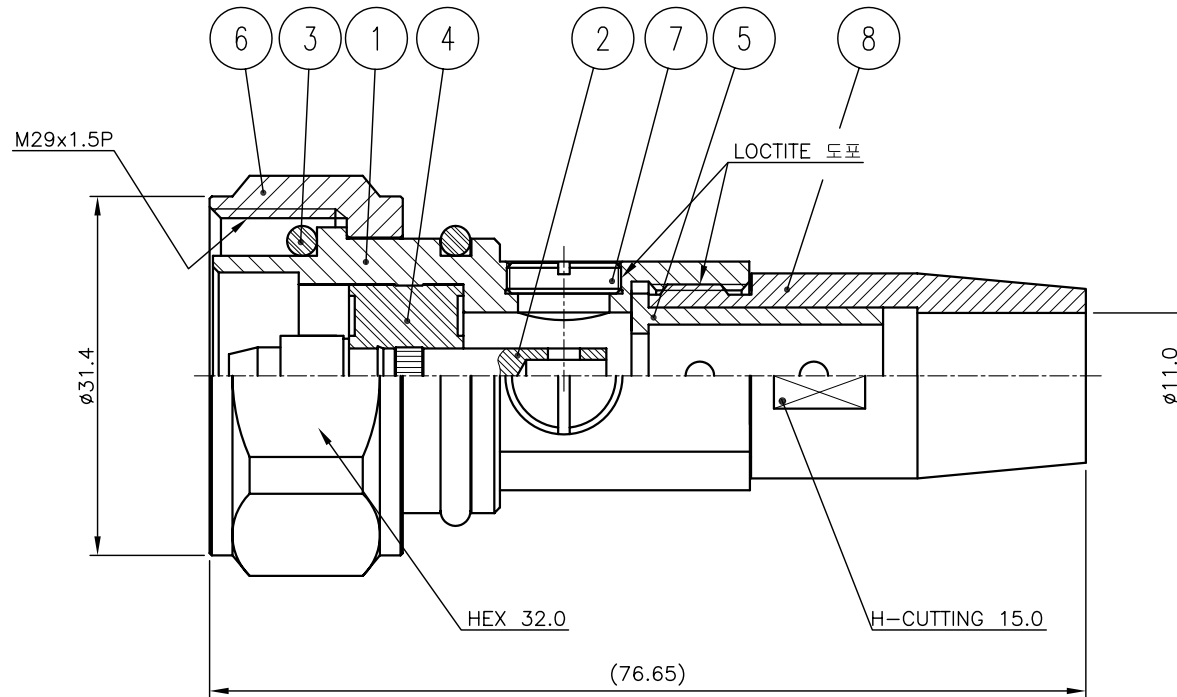
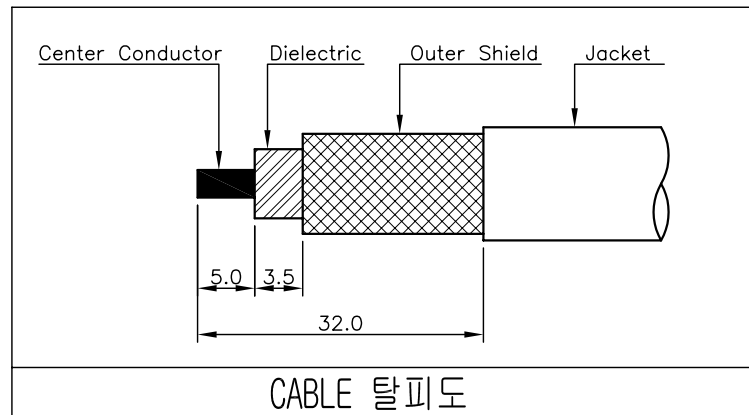


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	김인철	최영호	2009.10.15.
A	설변처리No.201009-0002 (내경부 홀 추가)	김인철	최영호	2010.09.06.



* 조립 주기

1. 탈피도에 맞게 탈피 작업
2. CABLE + ⑦ BACK NUT 양단 끼워넣기 (방향주의)
3. ⑤ INSERT + 탈피 CABLE SOLDER
4. ① BODY + ④ 절연체 억지끼움 ② PIN 조립
5. 3번 조립품 + 4번 조립품 PIN SOLDERING 작업
6. ⑥ CAP + ① BODY 조립



8	BACK NUT	1	MBsBD	Nickel Plate	DBN00163-5/3
7	COVER	2	MBsBD	SUCO Plate	DCS00028-5/2
6	CAP	1	MBsBD	Nickel Plate	DCU00078-5/2
5	INSERT	1	MBsBD	SUCO Plate (3μm)	DIS00153-5/1
4	INSULATOR	1	TEFLON		DIN01672-N/1
3	GASKET	2	MBsBD		DGK00054-N/1 (G5006)
2	CONTACT	1	MBsBD	Silver Plate (7μm)	DCT02118-5/1
1	BODY	1	MBsBD	SUCO Plate (6μm)	DBD02616-5/2 DBD02616-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2010. 09. 06.	
	Angle	APPROVED BY Y.H.CHOI	
MATERIAL		CHECKED BY	
		DRAWN BY I.C.KIM	
FINISH		SCALE	UNIT
		4/1	mm



RF & MICROWAVE
TECHNOLOGY
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Fax : 82-32-347-8017

TITLE 7/16 DIN50 CABLE PS RG393

DWG NO. CN02469-7/3

REVISION A SHEET 1 of 1

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